


PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

| | | |
|-----------------------------|---|--------------------------------------|
| 1.1 Company |  | STMicroelectronics International N.V |
| 1.2 PCN No. | ADG/24/14639 | |
| 1.3 Title of PCN | Additional capacity for SMLVT3V3 at same subcontractor in China | |
| 1.4 Product Category | SMLVT3V3 | |
| 1.5 Issue date | 2024-03-20 | |

2. PCN Team

| | |
|----------------------------------|--------------------|
| 2.1 Contact supplier | |
| 2.1.1 Name | PIKE EMMA |
| 2.1.2 Phone | +44 1628896111 |
| 2.1.3 Email | emma.pike@st.com |
| 2.2 Change responsibility | |
| 2.2.1 Product Manager | Stephane CHAMARD |
| 2.1.2 Marketing Manager | Philippe LEGER |
| 2.1.3 Quality Manager | Jean-Paul REBRASSE |

3. Change

| | | |
|---------------------|---------------------------|-----------------------------------|
| 3.1 Category | 3.2 Type of change | 3.3 Manufacturing Location |
| Machines | (Not Defined) | Subcontractor in China |

4. Description of change

| | | |
|--|------------------------|---|
| | Old | New |
| 4.1 Description | Assembly line in China | Assembly line in China with additional capacity |
| 4.2 Anticipated Impact on form,fit, function, quality, reliability or processability? | No | |

5. Reason / motivation for change

| | |
|-----------------------------|--|
| 5.1 Motivation | Standardization of assembly process and method for all TVS parts in SMB package. STMicroelectronics will increase its production capacity to better serve its customers through service improvement and lead time reduction. |
| 5.2 Customer Benefit | CAPACITY INCREASE |

6. Marking of parts / traceability of change

| | |
|------------------------|---|
| 6.1 Description | New Finished Good/Type print on carton labels |
|------------------------|---|

7. Timing / schedule

| | |
|--|--------------|
| 7.1 Date of qualification results | 2024-03-18 |
| 7.2 Intended start of delivery | 2024-06-18 |
| 7.3 Qualification sample available? | Upon Request |

8. Qualification / Validation

| | | | |
|---|----------------------------|-------------------|------------|
| 8.1 Description | 14639 2401QRP.pdf | | |
| 8.2 Qualification report and qualification results | Available (see attachment) | Issue Date | 2024-03-20 |

9. Attachments (additional documentations)

14639 Public product.pdf
 14639 SMLVT3V3 HD conversion.pdf
 14639 2401QRP.pdf

| 10. Affected parts | | |
|-------------------------|-------------------------|--------------------------|
| 10.1 Current | | 10.2 New (if applicable) |
| 10.1.1 Customer Part No | 10.1.2 Supplier Part No | 10.1.2 Supplier Part No |
| SMLVT3V3 | SMLVT3V3 | |

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